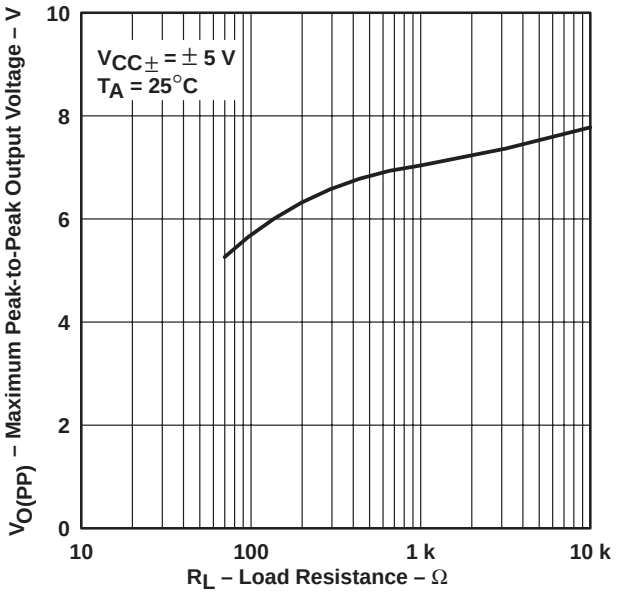
- **Excellent Output Drive Capability**
  $V_O = \pm 2.5$ V Min at $R_L = 100\ \Omega$, $V_{CC\pm} = \pm 5$ V
  $V_O = \pm 12.5$ V Min at $R_L = 600\ \Omega$, $V_{CC\pm} = \pm 15$ V
- **Low Supply Current . . . 280 μA Typ**
- **Decompensated for High Slew Rate and Gain-Bandwidth Product**
  A_{VD} = 0.5 Min
  Slew Rate = 10 V/μs Typ
  Gain-Bandwidth Product = 6.5 MHz Typ
- **Wide Operating Supply Voltage Range**
  $V_{CC\pm} = \pm 3.5$ V to ± 18 V
- **High Open-Loop Gain . . . 280 V/mV Typ**
- **Low Offset Voltage . . . 500 μV Max**
- **Low Offset Voltage Drift With Time**
  0.04 μV/Month Typ
- **Low Input Bias Current . . . 5 pA Typ**

description

The TLE2161, TLE2161A, and TLE2161B are JFET-input, low-power, precision operational amplifiers manufactured using the Texas Instruments Excalibur process. Decompensated for stability with a minimum closed-loop gain of 5, these devices combine outstanding output drive capability with low power consumption, excellent dc precision, and high gain-bandwidth product.

In addition to maintaining the traditional JFET advantages of fast slew rates and low input bias and offset currents, the Excalibur process offers outstanding parametric stability over time and temperature. This results in a device that remains precise even with changes in temperature and over years of use.

MAXIMUM PEAK-TO-PEAK OUTPUT VOLTAGE vs LOAD RESISTANCE



AVAILABLE OPTIONS

T_A	V_{IO}max AT 25°C	PACKAGE			
		SMALL OUTLINE (D)	CHIP CARRIER (FK)	CERAMIC DIP (JG)	PLASTIC DIP (P)
0°C to 70°C	500 μV	—	—	—	TLE2161BCP
	1.5 mV	TLE2161ACD			TLE2161ACP
	3 mV	TLE2161CD	—	—	TLE2161CP
–40°C to 85°C	500 μV	—	—	—	TLE2161BIP
	1.5 mV	TLE2161AID			TLE2161AIP
	3 mV	TLE2161ID	—	—	TLE2161IP
–55°C to 125°C	500 μV	—	—	TLE2161BMJG	TLE2161BMP
	1.5 mV	TLE2161AMD	TLE2161AMFK	TLE2161AMJG	TLE2161AMP
	3 mV	TLE2161MD	TLE2161MFK	TLE2161MJG	TLE2161MP

The D packages are available taped and reeled. Add R suffix to device type (e.g., TLE2161ACDR).

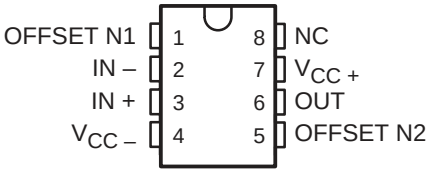
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

description (continued)

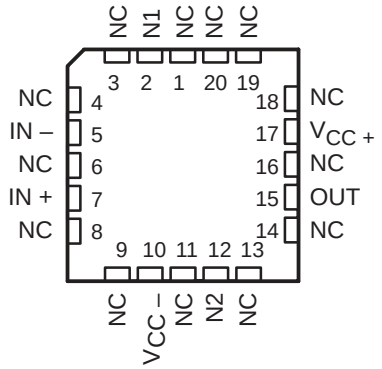
A variety of available options includes small-outline packages and chip-carrier versions for high-density system applications.

The C-suffix devices are characterized for operation from 0°C to 70°C. The I-suffix devices are characterized for operation from – 40°C to 85°C. The M-suffix devices are characterized for operation over the full military temperature range of – 55°C to 125°C.

D, JG, OR P PACKAGE
(TOP VIEW)

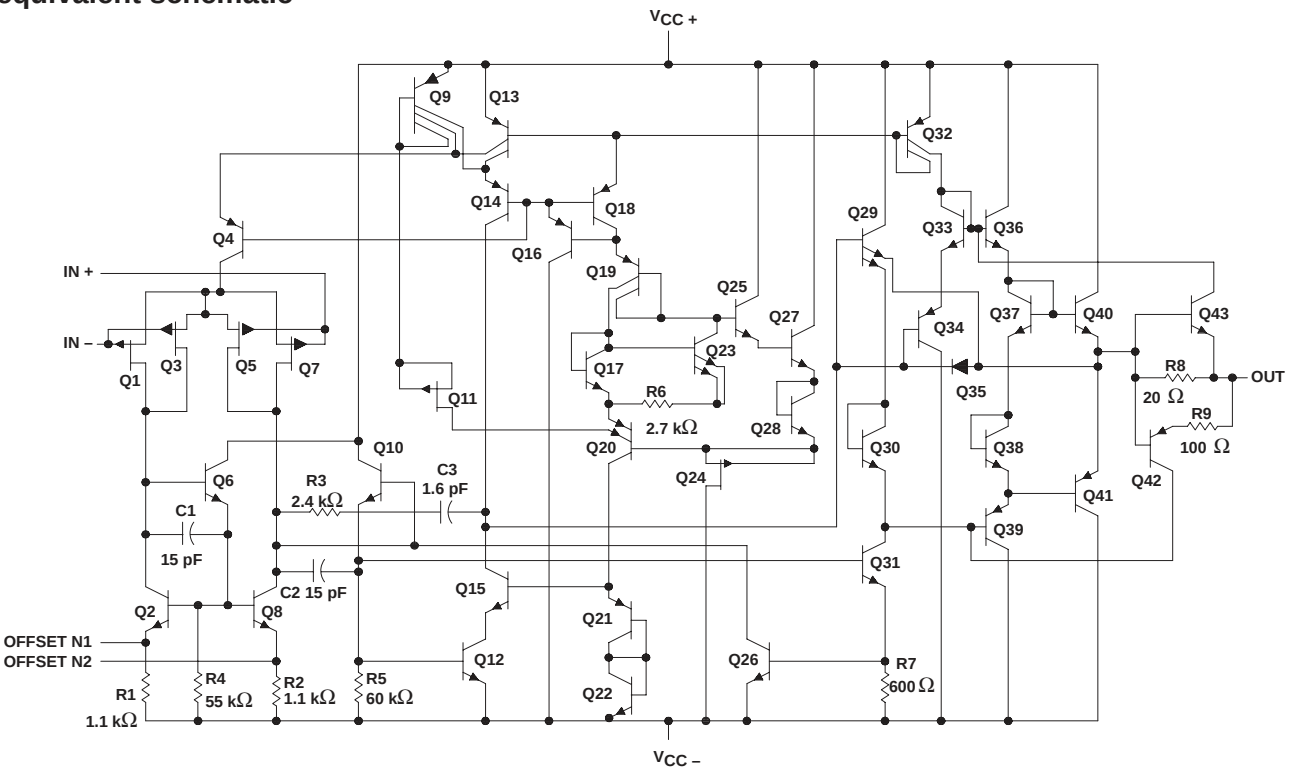


FK PACKAGE
(TOP VIEW)



NC – No internal connection

equivalent schematic



All component values are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{CC+} (see Note 1) . . . . . 19 V
Supply voltage, V_{CC-} . . . . . – 19 V
Differential input voltage, V_{ID} (see Note 2) . . . . . ± 38 V
Input voltage range, V_I (any input) . . . . . $V_{CC\pm}$
Input current, I_I (each input) . . . . . ± 1 mA
Output current, I_O . . . . . ± 80 mA
Total current into V_{CC+} . . . . . 80 mA
Total current out of V_{CC-} . . . . . 80 mA
Duration of short-circuit current at (or below) 25°C (see Note 3) . . . . . unlimited
Continuous total power dissipation . . . . . See Dissipation Rating Table
Operating free-air temperature range, T_A: C suffix . . . . . 0°C to 70°C
I suffix . . . . . – 40°C to 85°C
M suffix . . . . . – 55°C to 125°C
Storage temperature range, T_{stg} . . . . . – 65°C to 150°C
Case temperature for 60 seconds: FK package . . . . . 260°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: D or P package . . . . . 260°C
Lead temperature 1,6 mm (1/16 inch) from case for 60seconds: JG package . . . . . 300°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values, except differential voltages, are with respect to the midpoint between V_{CC+}, and V_{CC-}.
2. Differential voltages are at IN+ with respect to IN–.
3. The output may be shorted to either supply. Temperature and /or supply voltages must be limited to ensure that the maximum dissipation rating is not exceeded.

DISSIPATION RATING TABLE

PACKAGE	$T_A \le 25°C$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25°C$	$T_A = 70°C$ POWER RATING	$T_A = 85°C$ POWER RATING	$T_A = 125°C$ POWER RATING
D	725 mW	5.8 mW/°C	464 mW	377 mW	145 mW
FK	1375 mW	11.0 mW/°C	880 mW	715 mW	275 mW
JG	1050 mW	8.4 mW/°C	672 mW	546 mW	210 mW
P	1000 mW	8.0 mW/°C	640 mW	520 mW	200 mW

recommended operating conditions

		C SUFFIX		I SUFFIX		M SUFFIX		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
Supply voltage, $V_{CC\pm}$		±3.5	±18	±3.5	±18	+3.5	±18	V
Common-mode input voltage, V_{IC}	$V_{CC\pm}$ = ± 5 V	–1.6	4	–1.6	4	–1.6	4	V
	$V_{CC\pm}$ = ± 15 V	–11	13	–11	13	–11	13	
Operating free-air temperature, T_A		0	70	–40	85	–55	125	°C

electrical characteristics at specified free-air temperature, $V_{CC\pm}$ = ±5 V (unless otherwise noted)

PARAMETER			TEST CONDITIONS	T_A†	TLE2161C, TLE2161AC TLE2161BC			UNIT
					MIN	TYP	MAX	
V_{IO}	Input offset voltage	TLE2161C	V_{IC} = 0, R_S = 50 Ω	25°C		0.8	3.1	mV
				Full range			4	
		TLE2161AC		25°C		0.6	2.6	
				Full range			3.5	
		TLE2161BC		25°C		0.5	1.9	
				Full range			2.4	
α_{VIO}	Temperature coefficient of input offset voltage			Full range		6		μV/°C
	Input offset voltage long-term drift (see Note 4)			25°C		0.04		μV/mo
I_{IO}	Input offset current			25°C		1		pA
				Full range			0.8	nA
I_{IB}	Input bias current			25°C		3		pA
				Full range			2	nA
V_{ICR}	Common-mode input voltage range			25°C	−1.6 to 4	−2 to 6		V
				Full range	−1.6 to 4			V
V_{OM+}	Maximum positive peak output voltage swing		R_L = 10 kΩ	25°C	3.5	3.7		V
				Full range	3.3			
			R_L = 100 Ω	25°C	2.5	3.1		
				Full range	2			
V_{OM-}	Maximum negative peak output voltage swing		R_L = 10 kΩ	25°C	−3.7	−3.9		V
				Full range	−3.3			
			R_L = 100 Ω	25°C	−2.5	−2.7		
				Full range	−2			
A_{VD}	Large-signal differential voltage amplification		V_O = ±2.8 V, R_L = 10 kΩ	25°C	15	80		V/mV
				Full range	2			
			V_O = 0 to 2 V, R_L = 100 Ω	25°C	0.75	45		
				Full range	0.5			
			V_O = 0 to −2 V, R_L = 100 Ω	25°C	0.5	3		
				Full range	0.25			
r_i	Input resistance			25°C		10^{12}		Ω
c_i	Input capacitance			25°C		4		pF
z_o	Open-loop output impedance		I_O = 0	25°C		280		Ω
CMRR	Common-mode rejection ratio		V_{IC}=V_{ICR}min, R_S = 50 Ω	25°C	65	82		dB
				Full range	65			
k_{SVR}	Supply-voltage rejection ratio ($\Delta V_{CC\pm}/\Delta V_{IO}$)		$V_{CC\pm}$ = ±5 V to ±15 V, R_S = 50 Ω	25°C	75	93		dB
				Full range	75			
I_{CC}	Supply current		V_O = 0, No load	25°C		280	325	μA
				Full range			350	
ΔI_{CC}	Supply-current change over operating temperature range			Full range		29		μA

† Full range is 0°C to 70°C.

NOTE 4: Typical values are based on the input offset voltage shift observed through 168 hours of operating life test at T_A = 150°C extrapolated to T_A = 25°C using the Arrhenius equation and assuming an activation energy of 0.96 eV.

operating characteristics at specified free-air temperature, $V_{CC\pm}$ = ±5 V (unless otherwise noted)

PARAMETER		TEST CONDITIONS	T_A†	TLE2161C, TLE2161AC TLE2161BC			UNIT
				MIN	TYP	MAX	
SR	Slew rate (see Figure 1)	A_{VD} = 5, R_L = 10 kΩ, C_L = 100 pF	25°C	7	10		V/μs
			Full range	5			
V_n	Equivalent input noise voltage (see Figure 2)	R_S = 20 Ω, f = 10 Hz	25°C		59	100	nV/√Hz
		R_S = 20 Ω, f = 1 kHz			43	60	
$V_{n(PP)}$	Peak-to-peak equivalent input noise voltage	f = 0.1 Hz to 10 Hz	25°C		1.1		μV
I_n	Equivalent input noise current	f = 1 kHz	25°C		1		fA/√Hz
THD	Total harmonic distortion	$V_{O(PP)}$ = 2 V, A_{VD} = 5, f = 10 kHz, R_L = 10 kΩ	25°C		0.025%		
	Gain-bandwidth product (see Figure 3)	f = 100 kHz, R_L = 10 kΩ, C_L = 100 pF	25°C		5.8		MHz
		f = 100 kHz, R_L = 100 kΩ, C_L = 100 pF			4.3		
t_s	Settling time	ε = 0.1%	25°C		5		μs
		ε = 0.01%			10		
B_{OM}	Maximum output-swing bandwidth	A_{VD} = 5, R_L = 10 kΩ	25°C		420		kHz
ϕ_m	Phase margin (see Figure 3)	A_{VD} = 5, R_L = 10 kΩ, C_L = 100 pF	25°C		70°		
		A_{VD} = 5, R_L = 100 Ω, C_L = 100 pF			84°		

† Full range is 0°C to 70°C.

electrical characteristics at specified free-air temperature, $V_{CC\pm}$ = ± 15 V (unless otherwise noted)

PARAMETER			TEST CONDITIONS		T_A†	TLE2161C, TLE2161AC TLE2161BC			UNIT
						MIN	TYP	MAX	
V_{IO}	Input offset voltage	TLE2161C	V_{IC} = 0,	R_S = 50 Ω	25°C		0.6	3	mV
					Full range			3.9	
		TLE2161AC			25°C		0.5	1.5	
					Full range			2.5	
		TLE2161BC			25°C		0.3	0.5	
					Full range			1	
α_{VIO}	Temperature coefficient of input offset voltage				Full range		6		μV/°C
	Input offset voltage long-term drift (see Note 4)				25°C		0.04		μV/mo
I_{IO}	Input offset current				25°C		2		pA
					Full range			1	nA
I_{IB}	Input bias current				25°C		4		pA
					Full range			3	nA
V_{ICR}	Common-mode input voltage range				25°C	–11 to 13	–12 to 16		V
					Full range	–11 to 13			V
V_{OM+}	Maximum positive peak output voltage swing		R_L = 10 kΩ		25°C	13.2	13.7		V
					Full range	13			
			R_L = 600 Ω		25°C	12.5	13.2		
					Full range	12			
V_{OM-}	Maximum negative peak output voltage swing		R_L = 10 kΩ		25°C	–13.2	–13.7		V
					Full range	–13			
			R_L = 600 Ω		25°C	–12.5	–13		
					Full range	–12			
A_{VD}	Large-signal differential voltage amplification		V_O = ±10 V,	R_L = 10 kΩ	25°C	30	230		V/mV
					Full range	20			
			V_O = 0 to 8 V,	R_L = 600 Ω	25°C	25	100		
					Full range	10			
			V_O = 0 to – 8 V,	R_L = 600 Ω	25°C	3	25		
					Full range	1			
r_i	Input resistance				25°C		10^{12}		Ω
c_i	Input capacitance				25°C		4		pF
z_o	Open-loop output impedance		I_O = 0		25°C		280		Ω
CMRR	Common-mode rejection ratio		V_{IC} = V_{ICR}min,	R_S = 50 Ω	25°C	72	90		dB
					Full range	70			
k_{SVR}	Supply-voltage rejection ratio ($\Delta V_{CC\pm}/\Delta V_{IO}$)		$V_{CC\pm}$ = ±5 V to ±15 V, RS = 50 Ω		25°C	75	93		dB
					Full range	75			
I_{CC}	Supply current		VO = 0,	No load	25°C		290	350	μA
					Full range			375	
ΔI_{CC}	Supply-current change over operating temperature range				Full range		34		μA

† Full range is 0°C to 70°C.

NOTE 4: Typical values are based on the input offset voltage shift observed through 168 hours of operating life test at T_A = 150°C extrapolated to T_A = 25°C using the Arrhenius equation and assuming an activation energy of 0.96 eV.

operating characteristics at specified free-air temperature, $V_{CC\pm}$ = ±15 V (unless otherwise noted)

PARAMETER		TEST CONDITIONS			T_A†	TLE2161C, TLE2161AC TLE2161BC			UNIT
						MIN	TYP	MAX	
SR	Slew rate (see Figure 1)	A_{VD} = 5,	R_L = 10 kΩ,	C_L = 100 pF	25°C	7	10		V/μs
					Full range	5			
V_n	Equivalent input noise voltage (see Figure 2)	R_S = 20 Ω,	f = 10 Hz		25°C		70	100	nV/√Hz
		R_S = 20 Ω,	f = 1 kHz				40	60	
$V_{n(PP)}$	Peak-to-peak equivalent input noise voltage	f = 0.1 Hz to 10 Hz			25°C		1.1		μV
I_n	Equivalent input noise current	f = 1 kHz			25°C		1.1		fA/√Hz
THD	Total harmonic distortion	$V_{O(PP)}$ = 2 V, R_L = 10 kΩ	A_{VD} = 5,	f = 10 kHz,	25°C		0.025%		
	Gain-bandwidth product (see Figure 3)	f = 100 kHz,	R_L = 10 kΩ,	C_L = 100 pF	25°C		6.4		MHz
		f = 100 kHz,	R_L = 600 Ω,	C_L = 100 pF			5.6		
t_s	Settling time	ε = 0.1%			25°C		5		μs
		ε = 0.01%					10		
B_{OM}	Maximum output-swing bandwidth	A_{VD} = 5,	R_L = 10 kΩ		25°C		116		kHz
ϕ_m	Phase margin (see Figure 3)	A_{VD} = 5,	R_L = 10 kΩ,	C_L = 100 pF	25°C		72°		
		A_{VD} = 5,	R_L = 600 Ω,	C_L = 100 pF			78°		

† Full range is 0°C to 70°C.

electrical characteristics at specified free-air temperature, $V_{CC\pm}$ = ± 5 V (unless otherwise noted)

PARAMETER			TEST CONDITIONS	T_A†	TLE2161I, TLE2161AI TLE2161BI			UNIT
					MIN	TYP	MAX	
V_{IO}	Input offset voltage	TLE2161I	V_{IC} = 0, R_S = 50 Ω	25°C		0.8	3.1	mV
				Full range			4.4	
		TLE2161AI		25°C		0.6	2.6	
				Full range			3.9	
		TLE2161BI		25°C		0.5	1.9	
				Full range			2.7	
α_{VIO}	Temperature coefficient of input offset voltage			Full range		6		μV/°C
	Input offset voltage long-term drift (see Note 4)			25°C		0.04		μV/mo
I_{IO}	Input offset current			25°C		1		pA
				Full range			2	nA
I_{IB}	Input bias current			25°C		3		pA
				Full range			4	nA
V_{ICR}	Common-mode input voltage range			25°C	−1.6 to 4	−2 to 6		V
				Full range	−1.6 to 4			
V_{OM+}	Maximum positive peak output voltage		R_L = 10 kΩ	25°C	3.5	3.7		V
				Full range	3.1			
			R_L = 100 Ω	25°C	2.5	3.1		
				Full range	2			
V_{OM-}	Maximum negative peak output voltage swing		R_L = 10 kΩ	25°C	−3.7	−3.9		V
				Full range	−3.1			
			R_L = 100 Ω	25°C	−2.5	−2.7		
				Full range	−2			
A_{VD}	Large-signal differential voltage amplification		V_O = ±2.8 V, R_L = 10 kΩ	25°C	15	80		V/mV
				Full range	2			
			V_O = 0 to 2 V, R_L = 100 Ω	25°C	0.75	45		
				Full range	0.5			
			V_O = 0 to −2 V, R_L = 100 Ω	25°C	0.5	3		
				Full range	0.25			
r_i	Input resistance			25°C		10^{12}		Ω
c_i	Input capacitance			25°C		4		pF
z_o	Open-loop output impedance		I_O = 0	25°C		280		Ω
CMRR	Common-mode rejection ratio		V_{IC}=V_{ICR}min, R_S = 50 Ω	25°C	65	82		dB
				Full range	65			
k_{SVR}	Supply-voltage rejection ratio ($\Delta V_{CC\pm}/\Delta V_{IO}$)		$V_{CC\pm}$ = ±5 V to ± 15 V, R_S = 50 Ω	25°C	75	93		dB
				Full range	65			
I_{CC}	Supply current		V_O = 0, No load	25°C		280	325	μA
				Full range			350	
ΔI_{CC}	Supply-current change over operating temperature range			Full range		29		μA

† Full range is – 40°C to 85°C.

NOTE 4: Typical values are based on the input offset voltage shift observed through 168 hours of operating life test at T_A = 150°C extrapolated to T_A= 25°C using the Arrhenius equation and assuming an activation energy of 0.96 eV.

operating characteristics at specified free-air temperature, $V_{CC\pm}$ = ± 5 V (unless otherwise noted)

PARAMETER		TEST CONDITIONS	T_A†	TLE2161I, TLE2161AI TLE2161BI			UNIT
				MIN	TYP	MAX	
SR	Slew rate (see Figure 1)	A_{VD} = 5, R_L = 10 kΩ, C_L = 100 pF	25°C	7	10		V/μs
			Full range	5			
V_n	Equivalent input noise voltage (see Figure 2)	R_S = 20 Ω, f = 10 Hz	25°C		59	100	nV/√Hz
		R_S = 20 Ω, f = 1 kHz			43	60	
$V_{n(PP)}$	Peak-to-peak equivalent input noise voltage	f = 0.1 Hz to 10 Hz	25°C		1.1		μV
I_n	Equivalent input noise current	f = 1 kHz	25°C		1		fA/√Hz
THD	Total harmonic distortion	$V_{O(PP)}$ = 2 V, A_{VD} = 5, f = 10 kHz, R_L = 10 kΩ	25°C		0.025%		
	Gain-bandwidth product (see Figure 3)	f = 100 kHz, R_L = 10 kΩ, C_L = 100 pF	25°C		5.8		MHz
		f = 100 kHz, R_L = 100 Ω, C_L = 100 pF			4.3		
t_s	Settling time	ε = 0.1%	25°C		5		μs
		ε = 0.01%			10		
B_{OM}	Maximum output-swing bandwidth	A_{VD} = 5, R_L = 10 kΩ	25°C		420		kHz
ϕ_m	Phase margin (see Figure 3)	A_{VD} = 5, R_L = 10 kΩ, C_L = 100 pF	25°C		70°		
		A_{VD} = 5, R_L = 100 Ω, C_L = 100 pF			84°		

† Full range is – 40°C to 85°C.

electrical characteristics at specified free-air temperature, $V_{CC\pm}$ = ± 15 V (unless otherwise noted)

PARAMETER			TEST CONDITIONS	T_A†	TLE2161I, TLE2161AI TLE2161BI			UNIT
					MIN	TYP	MAX	
V_{IO}	Input offset voltage	TLE2161I	V_{IC} = 0, R_S = 50 Ω	25°C		0.6	3	mV
				Full range			4.3	
		TLE2161AI		25°C		0.5	1.5	
				Full range			2.9	
		TLE2161BI		25°C		0.3	0.5	
				Full range			1.3	
α_{VIO}	Temperature coefficient of input offset voltage			Full range		6		μV/°C
	Input offset voltage long-term drift (see Note 4)			25°C		0.04		μV/mo
I_{IO}	Input offset current			25°C		2		pA
				Full range			3	nA
I_{IB}	Input bias current			25°C		4		pA
				Full range			5	nA
V_{ICR}	Common-mode input voltage range			25°C	–11 to 13	–12 to 16		V
				Full range	–11 to 13			V
V_{OM+}	Maximum positive peak output voltage swing		R_L = 10 kΩ	25°C	13.2	13.7		V
				Full range	13			
			R_L = 600 Ω	25°C	12.5	13.2		
				Full range	12			
V_{OM-}	Maximum negative peak output voltage swing		R_L = 10 kΩ	25°C	–13.2	–13.7		V
				Full range	–13			
			R_L = 600 Ω	25°C	–12.5	–13		
				Full range	–12			
A_{VD}	Large-signal differential voltage amplification		V_O = ±10 V, R_L = 10 kΩ	25°C	30	230		V/mV
				Full range	20			
			V_O = 0 to 8 V, R_L = 600 Ω	25°C	25	100		
				Full range	10			
			V_O = 0 to – 8 V, R_L = 600 Ω	25°C	3	25		
				Full range	1			
r_i	Input resistance			25°C		10^{12}		Ω
c_i	Input capacitance			25°C		4		pF
z_o	Open-loop output impedance		I_O = 0	25°C		280		Ω
CMRR	Common-mode rejection ratio		V_{IC}=V_{ICR}min, R_S = 50 Ω	25°C	72	90		dB
				Full range	65			
k_{SVR}	Supply-voltage rejection ratio ($\Delta V_{CC\pm}/\Delta V_{IO}$)		$V_{CC\pm}$ = ±5 V to ±15 V, R_S = 50 Ω	25°C	75	93		dB
				Full range	65			
I_{CC}	Supply current		V_O = 0, No load	25°C		290	350	μA
				Full range			375	
ΔI_{CC}	Supply-current change over operating temperature range			Full range		34		μA

† Full range is – 40°C to 85°C.

NOTE 4: Typical values are based on the input offset voltage shift observed through 168 hours of operating life test at T_A= 150°C extrapolated to T_A = 25°C using the Arrhenius equation and assuming an activation energy of 0.96 eV.

operating characteristics at specified free-air temperature, $V_{CC\pm}$ = ± 15 V (unless otherwise noted)

PARAMETER		TEST CONDITIONS	T_A†	TLE2161I, TLE2161AI TLE2161IB			UNIT
				MIN	TYP	MAX	
SR	Slew rate (see Figure 1)	A_{VD} = 5, R_L = 10 kΩ, C_L = 100 pF	25°C	7	10		V/μs
			Full range	5			
V_n	Equivalent input noise voltage (see Figure 2)	R_S = 20 Ω, f = 10 Hz	25°C		70	100	nV/√Hz
		R_S = 20 Ω, f = 1 kHz			40	60	
$V_{n(PP)}$	Peak-to-peak equivalent input noise voltage	f = 0.1 Hz to 10 Hz	25°C		1.1		μV
I_n	Equivalent input noise current	f = 1 kHz	25°C		1.1		fA/√Hz
THD	Total harmonic distortion	$V_{O(PP)}$ = 2 V, A_{VD} = 5, f = 10 kHz, R_L = 10 kΩ	25°C		0.025%		
	Gain-bandwidth product (see Figure 3)	f = 100 kHz, R_L = 10 kΩ, C_L = 100 pF	25°C		6.4		MHz
		f = 100 kHz, R_L = 600 Ω, C_L = 100 pF			5.6		
t_s	Settling time	ε = 0.1%	25°C		5		μs
		ε = 0.01%			10		
B_{OM}	Maximum output-swing bandwidth	A_{VD} = 5, R_L = 10 kΩ	25°C		116		kHz
ϕ_m	Phase margin (see Figure 3)	A_{VD} = 5, R_L = 10 kΩ, C_L = 100 pF	25°C		72°		
		A_{VD} = 5, R_L = 600 Ω, C_L = 100 pF			78°		

† Full range is – 40°C to 85°C.

electrical characteristics at specified free-air temperature, $V_{CC\pm}$ = ± 5 V (unless otherwise noted)

PARAMETER			TEST CONDITIONS	T_A†	TLE2161M, TLE2161AM, TLE2161BM			UNIT
					MIN	TYP	MAX	
V_{IO}	Input offset voltage	TLE2161M	V_{IC} = 0, R_S = 50 Ω	25°C		0.8	3.1	mV
				Full range			6	
		TLE2161AM		25°C		0.6	2.6	
				Full range			4.6	
		TLE2161BM		25°C		0.5	1.9	
				Full range			3.1	
α_{VIO}	Temperature coefficient of input offset voltage			Full range		6		μV/°C
	Input offset voltage long-term drift (see Note 4)			25°C		0.04		μV/mo
I_{IO}	Input offset current			25°C		1		pA
				Full range			15	nA
I_{IB}	Input bias current			25°C		3		pA
				Full range			30	nA
V_{ICR}	Common-mode input voltage range			25°C	−1.6 to 4	−2 to 6		V
				Full range	−1.6 to 4			V
V_{OM+}	Maximum positive peak output voltage swing	All packages	R_L = 10 kΩ	25°C	3.5	3.7		V
				Full range	3			
		FK and JG packages	R_L = 600 Ω	25°C	2.5	3.6		V
				Full range	2			
		D and P packages	R_L = 100 Ω	25°C	2.5	3.1		
				Full range	2			
V_{OM-}	Maximum negative peak output voltage swing	All packages	R_L = 10 kΩ	25°C	−3.7	−3.9		V
				Full range	−3			
		FK and JG packages	R_L = 600 Ω	25°C	−2.5	−3.5		
				Full range	−2			
		D and P packages	R_L = 100 Ω	25°C	−2.5	−2.7		
				Full range	−2			
A_{VD}	Large-signal differential voltage amplification	All packages	V_O = ±2.8 V, R_L = 10 kΩ	25°C	15	80		V/mV
				Full range	2			
		FK and JG packages	V_O = 0 to 2.5 V, R_L = 600 Ω	25°C	1	65		
				Full range	0.5			
			V_O = 0 to −2.5 V, R_L = 600 Ω	25°C	1	16		
				Full range	0.5			
		D and P packages	V_O = 0 to 2 V, R_L = 100 Ω	25°C	0.75	45		
				Full range	0.5			
			V_O = 0 to −2 V, R_L = 100 Ω	25°C	0.5	3		
				Full range	0.25			

† Full range is – 55°C to 125°C.

NOTE 4: Typical values are based on the input offset voltage shift observed through 168 hours of operating life test at T_A = 150°C extrapolated to T_A = 25°C using the Arrhenius equation and assuming an activation energy of 0.96 eV.

electrical characteristics at specified free-air temperature, $V_{CC\pm}$ = ± 5 V (unless otherwise noted continued)

PARAMETER		TEST CONDITIONS	T_A†	TLE2161M TLE2161AM TLE2161BM			UNIT
				MIN	TYP	MAX	
r_i	Input resistance		25°C		10^{12}		Ω
c_i	Input capacitance		25°C		4		pF
z_o	Open-loop output impedance	I_O = 0	25°C		280		Ω
CMRR	Common-mode rejection ratio	V_{IC} = V_{ICR}min, R_S = 50 Ω	25°C	65	82		dB
			Full range	60			
k_{SVR}	Supply-voltage rejection ratio ($\Delta V_{CC\pm}/\Delta V_{IO}$)	$V_{CC\pm}$ = ±5 V to ±15 V, R_S = 50 Ω	25°C	75	93		dB
			Full range	65			
I_{CC}	Supply current	V_O = 0, No load	25°C		280	325	μA
			Full range			350	
ΔI_{CC}	Supply-current change over operating temperature range	V_O = 0, No load	Full range		39		μA

† Full range is – 55°C to 125°C.

operating characteristics, $V_{CC\pm}$ = ± 5 V, T_A = 25°C

PARAMETER		TEST CONDITIONS	TLE2161M TLE2161AM TLE2161BM			UNIT
			MIN	TYP	MAX	
SR	Slew rate (see Figure 1)	A_{VD} = 5, R_L = 10 kΩ, C_L = 100 pF		10		V/μs
V_n	Equivalent input noise voltage (see Figure 2)	R_S = 20 Ω, f = 10 Hz		59		nV/√Hz
		R_S = 20 Ω, f = 1 kHz		43		
$V_{n(PP)}$	Peak-to-peak equivalent input noise voltage	f = 0.1 Hz to 10 Hz		1.1		μV
I_n	Equivalent input noise current	f = 1 kHz		1		fA/√Hz
THD	Total harmonic distortion	A_{VD} = 5, $V_{O(PP)}$ = 2 V, f = 10 kHz, R_L = 10 kΩ		0.025%		
	Gain-bandwidth product (see Figure 3)	f = 100 kHz, R_L = 10 kΩ, C_L = 100 pF		5.8		MHz
		f = 100 kHz, R_L = 600 kΩ, C_L = 100 pF		4.3		
t_s	Settling time	ε = 0.1%		5		μs
		ε = 0.01%		10		
B_{OM}	Maximum output-swing bandwidth	A_{VD} = 5, R_L = 10 kΩ		420		kHz
ϕ_m	Phase margin (see Figure 3)	A_{VD} = 5, R_L = 10 kΩ, C_L = 100 pF		70°		
		A_{VD} = 5, R_L = 600 Ω, C_L = 100 pF		84°		

electrical characteristics at specified free-air temperature, $V_{CC\pm}$ = ±15 V (unless otherwise noted)

PARAMETER			TEST CONDITIONS	T_A†	TLE2161M, TLE2161AM, TLE2161BM			UNIT
					MIN	TYP	MAX	
V_{IO}	Input offset voltage	TLE2161M	V_{IC} = 0, R_S = 50 Ω	25°C		0.6	3	mV
				Full range			6	
		TLE2161AM		25°C		0.5	1.5	
				Full range			3.6	
		TLE2161BM		25°C		0.3	0.5	
				Full range			1.7	
α_{VIO}	Temperature coefficient of input offset voltage			Full range		6		μV/°C
	Input offset voltage long-term drift (see Note 4)			25°C		0.04		μV/mo
I_{IO}	Input offset current			25°C		2		pA
				Full range			20	nA
I_{IB}	Input bias current			25°C		4		pA
				Full range			40	nA
V_{ICR}	Common-mode input voltage range			25°C	–11 to 13	–12 to 16		V
				Full range	–11 to 13			V
V_{OM+}	Maximum positive peak output voltage swing		R_L = 10 kΩ	25°C	13.2	13.7		V
				Full range	12.5			
			R_L = 600 Ω	25°C	12.5	13.2		
				Full range	12			
V_{OM-}	Maximum negative peak output voltage swing		R_L = 10 kΩ	25°C	–13.2	–13.7		V
				Full range	–12.5			
			R_L = 600 Ω	25°C	–12.5	–13		
				Full range	–12			
A_{VD}	Large-signal differential voltage amplification		V_O = ±10 V, R_L = 10 kΩ	25°C	30	230		V/mV
				Full range	20			
			V_O = 0 to 8 V, R_L = 600 Ω	25°C	25	100		
				Full range	7			
			V_O = 0 to – 8 V, R_L = 600 Ω	25°C	3	25		
				Full range	1			
r_i	Input resistance			25°C		10^{12}		Ω
c_i	Input capacitance			25°C		4		pF
z_o	Open-loop output impedance		I_O = 0	25°C		280		Ω
CMRR	Common-mode rejection ratio		V_{IC} = V_{ICR}min, R_S = 50 Ω	25°C	72	90		dB
				Full range	65			
k_{SVR}	Supply-voltage rejection ratio ($\Delta V_{CC\pm}/\Delta V_{IO}$)		$V_{CC\pm}$ = ±5 V to ±15 V, R_S = 50 Ω	25°C	75	93		dB
				Full range	65			
I_{CC}	Supply current		V_O = 0, No load	25°C		290	350	μA
				Full range			375	
ΔI_{CC}	Supply-current change over operating temperature range			Full range		46		μA

† Full range is – 55°C to 125°C.

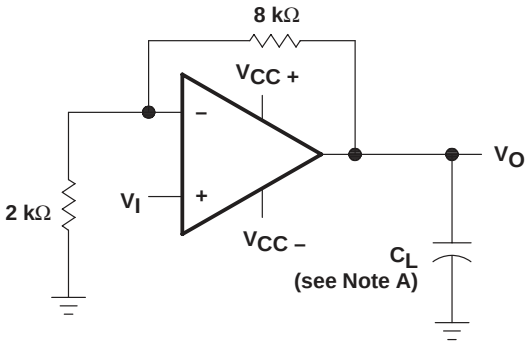
NOTE 4: Typical values are based on the input offset voltage shift observed through 168 hours of operating life test at T_A = 150°C extrapolated to T_A = 25°C using the Arrhenius equation and assuming an activation energy of 0.96 eV.

operating characteristics at specified free-air temperature, $V_{CC\pm}$ = ±15 V (unless otherwise noted)

PARAMETER		TEST CONDITIONS	T_A†	TLE2161M, TLE2161AM, TLE2161BM			UNIT
				MIN	TYP	MAX	
SR	Slew rate (see Figure 1)	A_{VD} = 5, R_L = 10 kΩ, C_L = 100 pF	25°C	7	10		V/μs
			Full range	5			
V_n	Equivalent input noise voltage (see Figure 2)	R_S = 20 Ω, f = 10 Hz	25°C		70		nV/√Hz
		R_S = 20 Ω, f = 1 kHz			40		
$V_{N(PP)}$	Peak-to-peak equivalent input noise voltage	f = 0.1 Hz to 10 Hz	25°C		1.1		μV
I_n	Equivalent input noise current	f = 1 Hz	25°C		1.1		fA/√Hz
THD	Total harmonic distortion	$V_{O(PP)}$ = 2 V, A_{VD} = 5, f = 10 kHz, R_L = 10 kΩ	25°C		0.025%		
	Gain-bandwidth product (see Figure 3)	f = 100 kHz, R_L = 10 kΩ, C_L = 100 pF	25°C		6.4		MHz
		f = 100 kHz, R_L = 600 Ω, C_L = 100 pF			5.6		
t_s	Settling time	ε = 0.1%	25°C		5		μs
		ε = 0.01%			10		
B_{OM}	Maximum output-swing bandwidth	A_{VD} = 5, R_L = 10 kΩ	25°C		116		kHz
ϕ_m	Phase margin (see Figure 3)	A_{VD} = 5, R_L = 10 kΩ, C_L = 100 pF	25°C		72°		
		A_{VD} = 5, R_L = 600 Ω, C_L = 100 pF			78°		

† Full range is – 55°C to 125°C.

PARAMETER MEASUREMENT INFORMATION



NOTE A: C_L includes fixture capacitance.

Figure 1. Slew-Rate Test Circuit

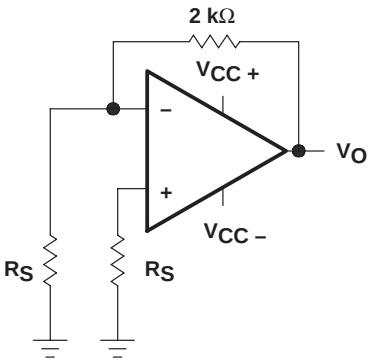
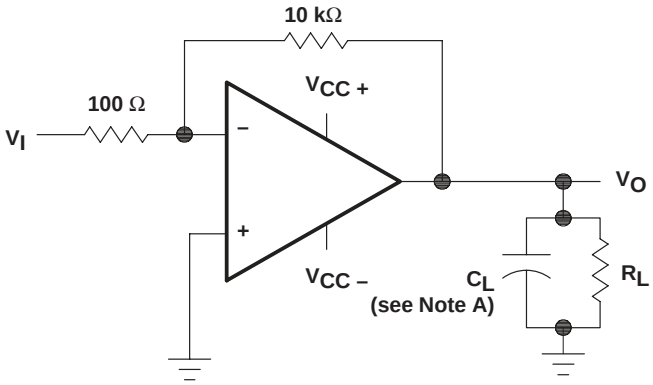


Figure 2. Noise-Voltage Test Circuit



NOTE A: C_L includes fixture capacitance.

Figure 3. Gain-Bandwidth Product and Phase-Margin Test Circuit

typical values

Typical values presented in this data sheet represent the median (50% point) of device parametric performance.

Input bias and offset current

At the picoampere bias-current level typical of the TLE2161, TLE2161A, and TLE2161B, accurate measurement of the bias current becomes difficult. Not only does this measurement require a picoammeter, but test socket leakages can easily exceed the actual device bias currents. To accurately measure these small currents, Texas Instruments uses a two-step process. The socket leakage is measured using picoammeters with bias voltages applied but with no device in the socket. The device is then inserted into the socket, and a second test that measures both the socket leakage and the device input bias current is performed. The two measurements are then subtracted algebraically to determine the bias current of the device.

TYPICAL CHARACTERISTICS

Table of Graphs

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V_{IO}	Input offset voltage	Distribution	4
I_{IB}	Input bias current	vs Common-mode input voltage vs Free-air temperature	5 6
I_{IO}	Input offset current	vs Free-air temperature	6
V_{ICR}	Common-mode input voltage range limits	vs Free-air temperature	7
V_{OM}	Maximum positive peak output voltage	vs Output current	8
V_{OM}	Maximum negative peak output voltage	vs Output current	9
V_{OM}	Maximum peak output voltage	vs Supply voltage	10, 11, 12
$V_{O(PP)}$	Maximum peak-to-peak output voltage	vs Frequency	13, 14, 15
A_{VD}	Large-signal differential voltage amplification	vs Frequency vs Free-air temperature	16 17
I_{OS}	Short-circuit output current	vs Elapsed time	18
	Large-signal voltage amplification	vs Free-air temperature	19
z_o	Output impedance	vs Frequency	20
CMRR	Common-mode rejection ratio	vs Frequency	21
I_{CC}	Supply current	vs Supply voltage vs Free-air temperature	22 23
	Pulse response	Small signal Large signal	24, 25 26, 27
	Noise voltage (referred to input)	0.1 to 10 Hz	28
V_n	Equivalent input noise voltage	vs Frequency	29
THD	Total harmonic distortion	vs Frequency	30, 31
	Gain-bandwidth product	vs Supply voltage vs Free-air temperature	32 33
ϕ_m	Phase margin	vs Supply voltage vs Free-air temperature	34 35
	Phase shift	vs Frequency	16

TYPICAL CHARACTERISTICS†

**TLE2161
DISTRIBUTION OF
INPUT OFFSET VOLTAGE**

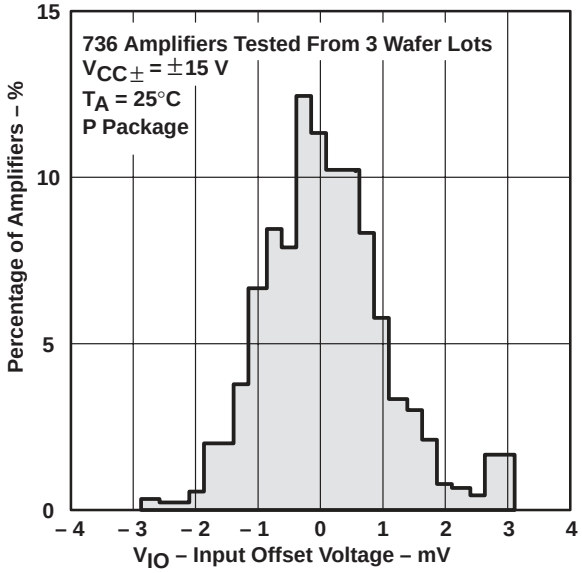

Figure 4

**INPUT BIAS CURRENT
vs
COMMON-MODE INPUT VOLTAGE**

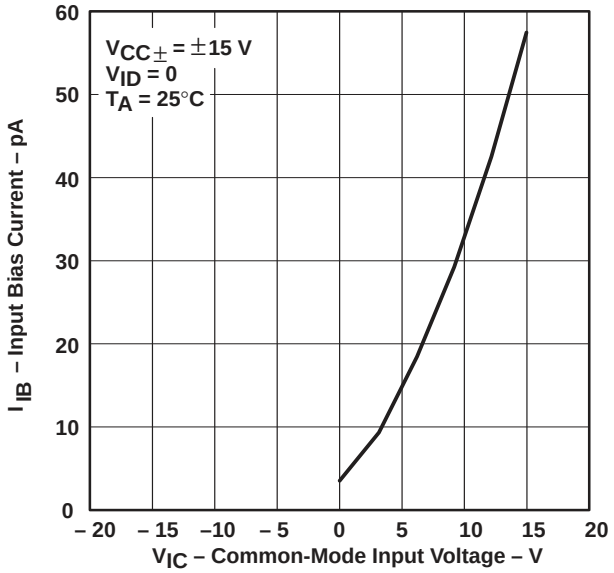

Figure 5

**INPUT BIAS CURRENT
AND INPUT OFFSET CURRENT
vs
FREE-AIR TEMPERATURE**

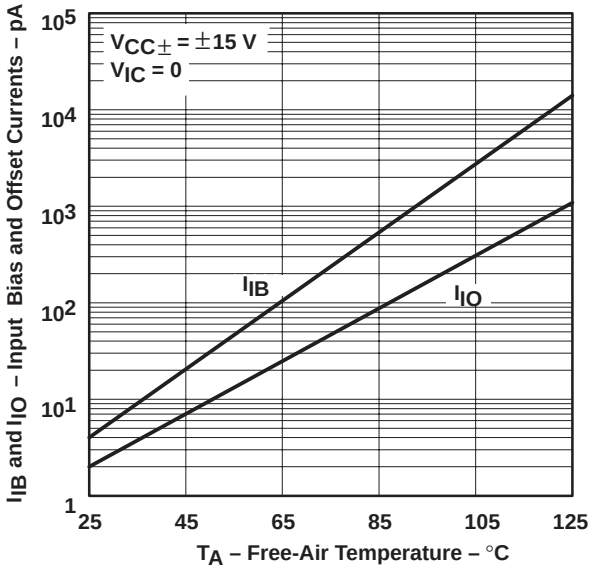

Figure 6

**COMMON-MODE
INPUT VOLTAGE RANGE LIMITS
vs
FREE-AIR TEMPERATURE**

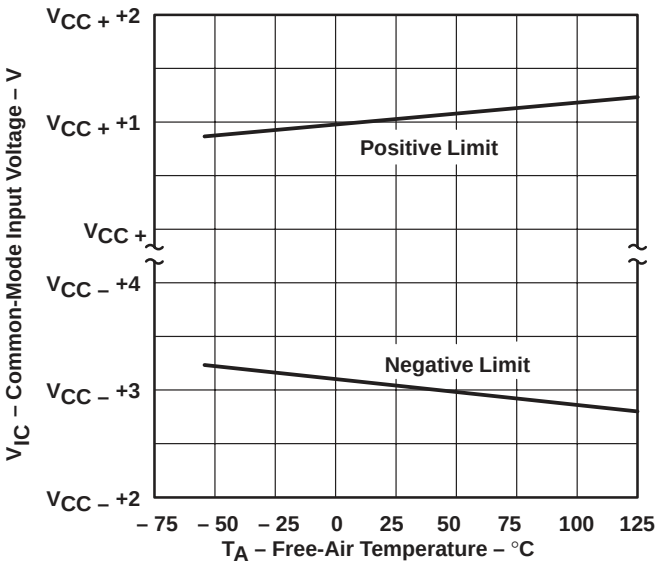

Figure 7

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

TYPICAL CHARACTERISTICS

MAXIMUM POSITIVE PEAK OUTPUT VOLTAGE vs OUTPUT CURRENT

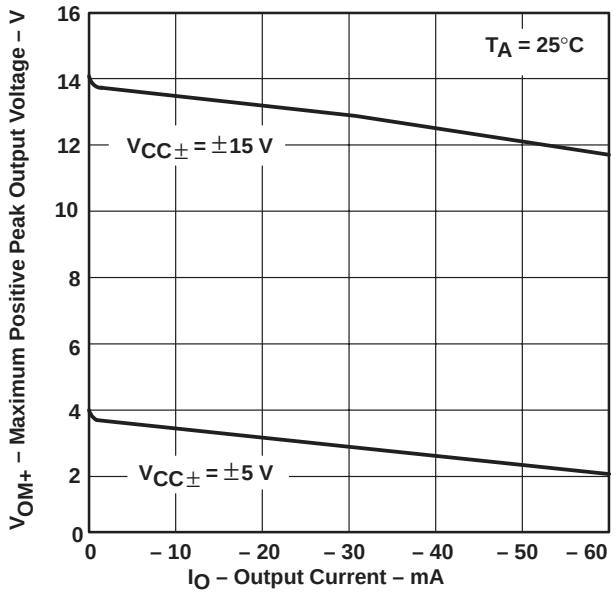

Figure 8

MAXIMUM NEGATIVE PEAK OUTPUT VOLTAGE vs OUTPUT CURRENT

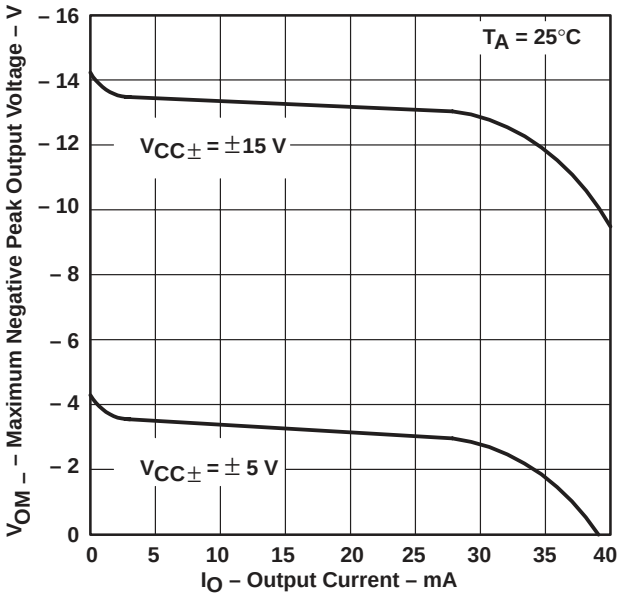

Figure 9

MAXIMUM PEAK OUTPUT VOLTAGE vs SUPPLY VOLTAGE

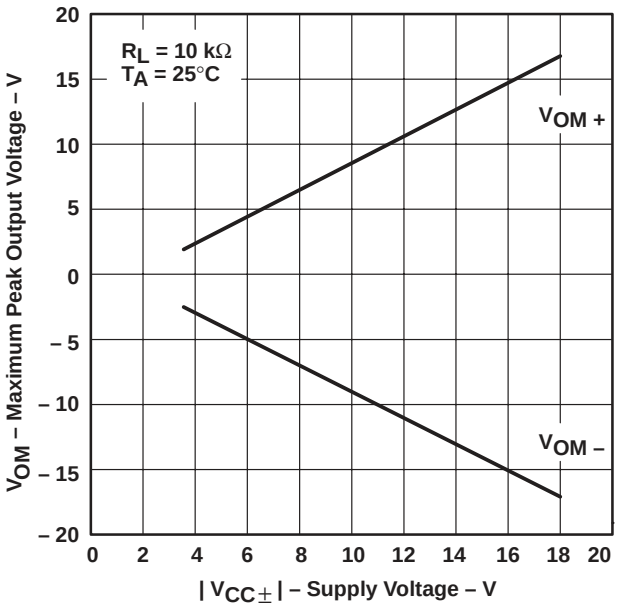

Figure 10

MAXIMUM PEAK OUTPUT VOLTAGE vs SUPPLY VOLTAGE

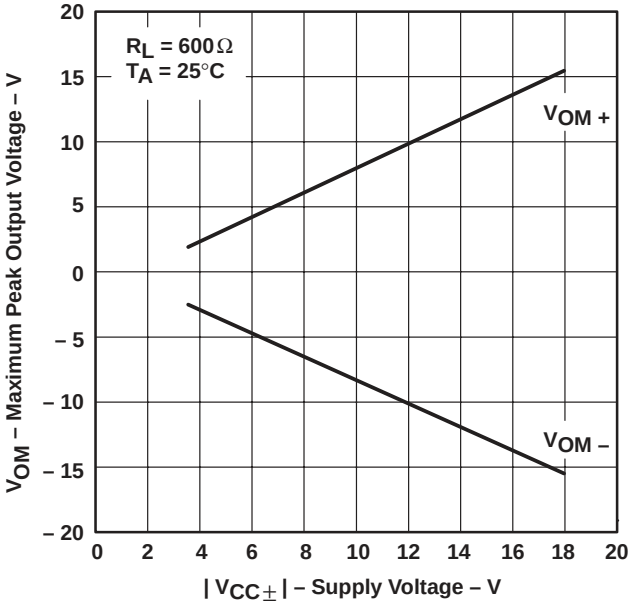

Figure 11

TYPICAL CHARACTERISTICS

MAXIMUM PEAK OUTPUT VOLTAGE vs SUPPLY VOLTAGE

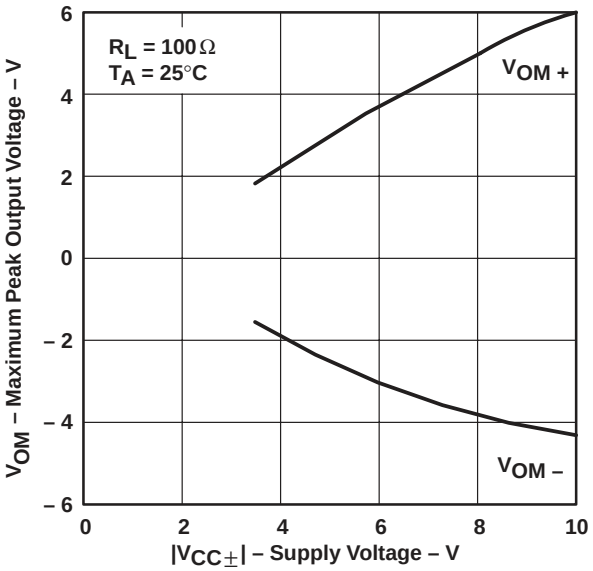

Figure 12

MAXIMUM PEAK-TO-PEAK OUTPUT VOLTAGE vs FREQUENCY

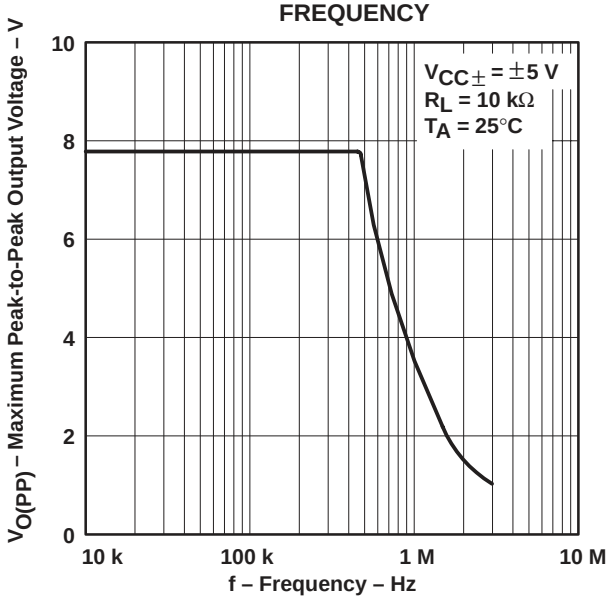

Figure 13

MAXIMUM PEAK-TO-PEAK OUTPUT VOLTAGE vs FRQUENCY

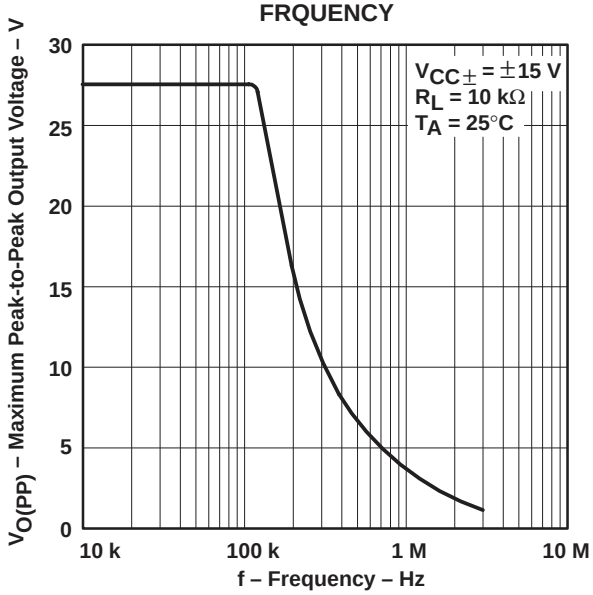

Figure 14

MAXIMUM PEAK-TO-PEAK OUTPUT VOLTAGE vs FREQUENCY

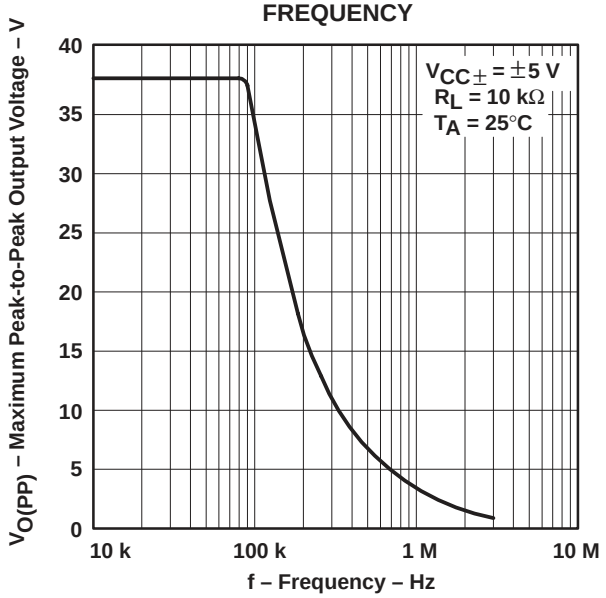

Figure 15

TYPICAL CHARACTERISTICS†

LARGE-SIGNAL DIFFERENTIAL VOLTAGE AMPLIFICATION AND PHASE SHIFT vs FRQUENCY

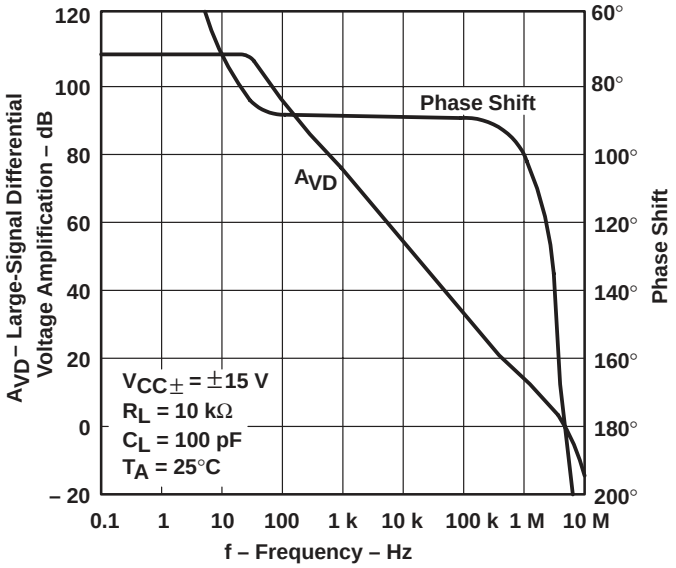

Figure 16

LARGE-SIGNAL DIFFERENTIAL VOLTAGE AMPLIFICATION vs FREE-AIR TEMPERATURE

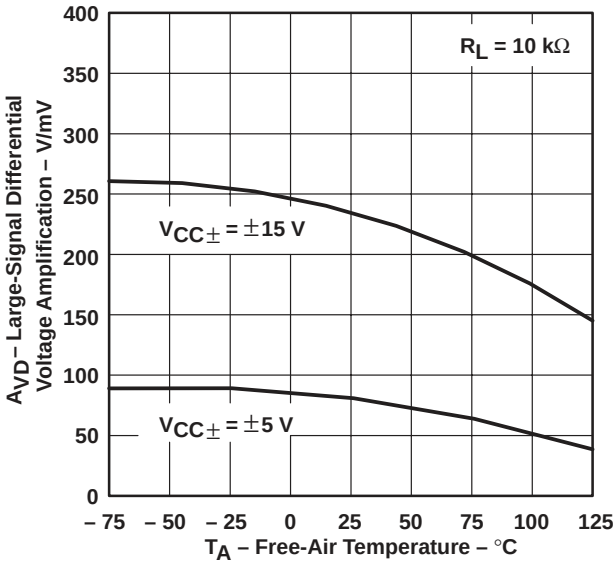

Figure 17

SHORT-CIRCUIT OUTPUT CURRENT vs ELAPSED TIME

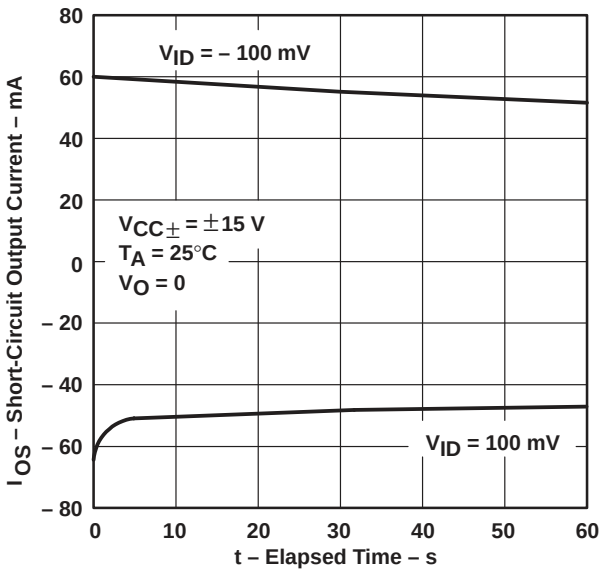

Figure 18

LARGE-SIGNAL VOLTAGE AMPLIFICATION vs FREE-AIR TEMPERATURE

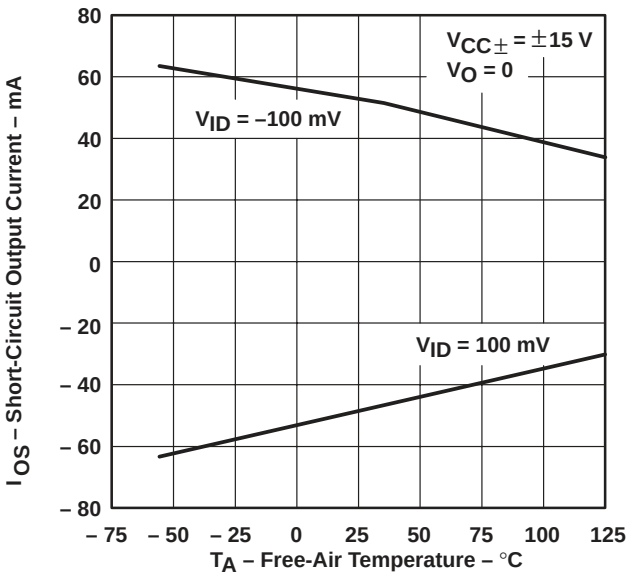

Figure 19

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

TYPICAL CHARACTERISTICS†

OUTPUT IMPEDANCE vs FREQUENCY

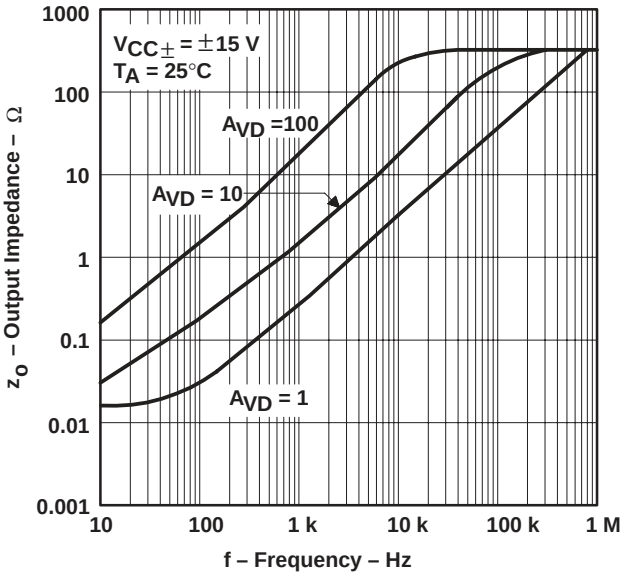

Figure 20

COMMON-MODE REJECTION RATIO vs FREQUENCY

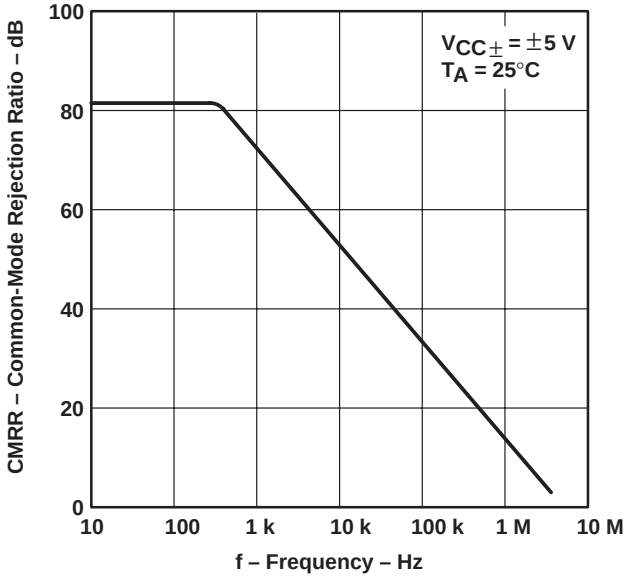

Figure 21

SUPPLY CURRENT vs SUPPLY VOLTAGE

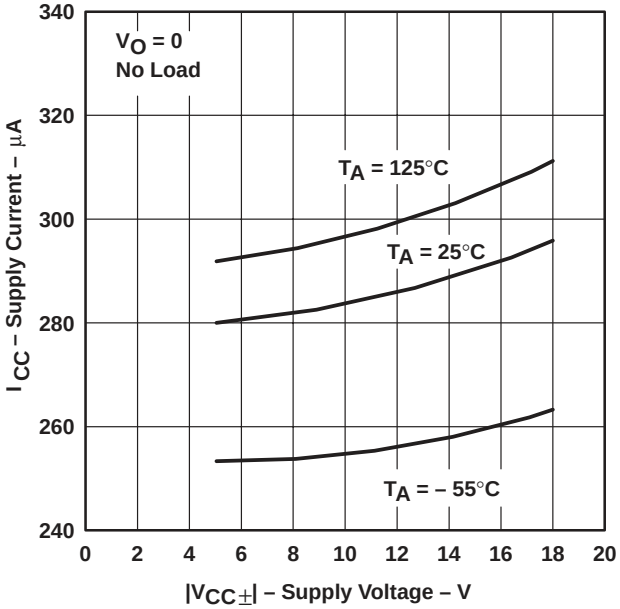

Figure 22

SUPPLY CURRENT vs FREE-AIR TEMPERATURE

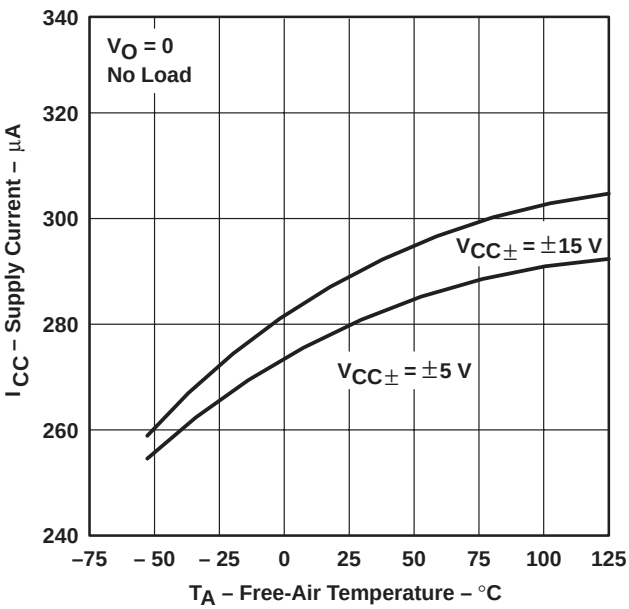

Figure 23

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

TYPICAL CHARACTERISTICS

SMALL-SIGNAL
PULSE RESPONSE

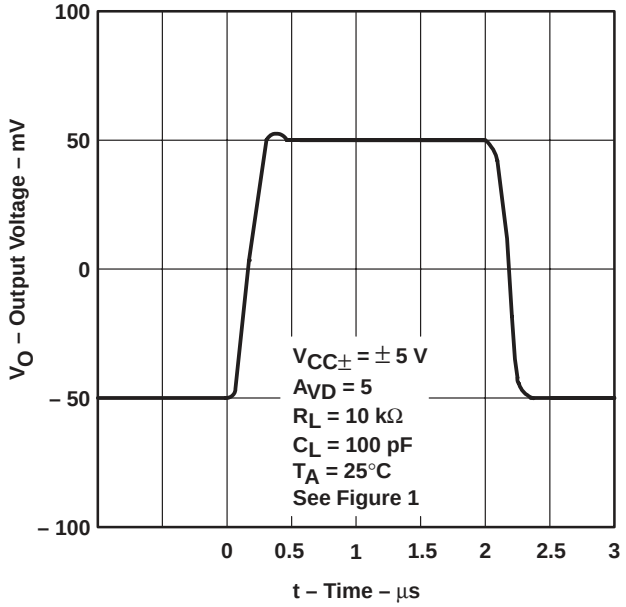

Figure 24

SMALL-SIGNAL
PULSE RESPONSE

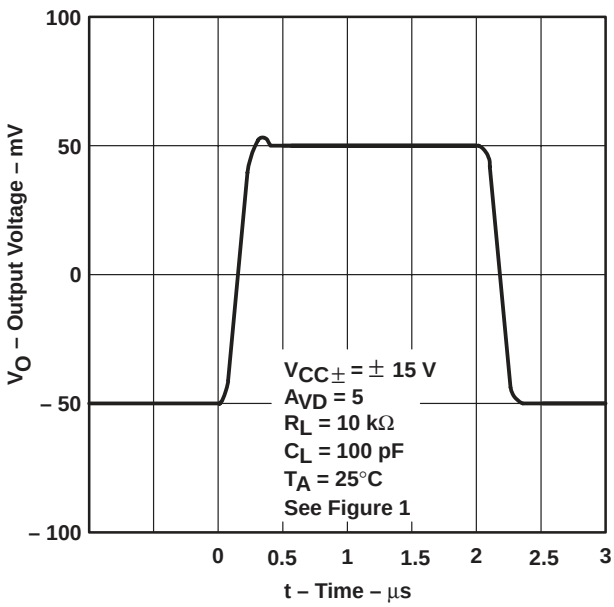

Figure 25

LARGE-SIGNAL
PULSE RESPONSE

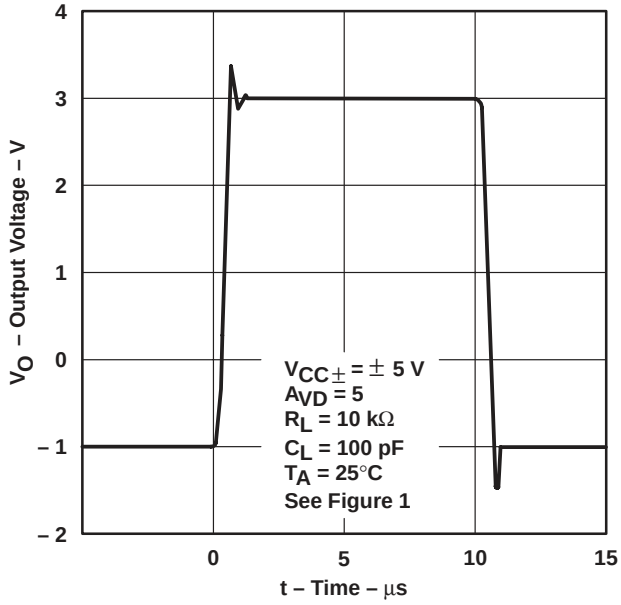

Figure 26

LARGE-SIGNAL
PULSE RESPONSE

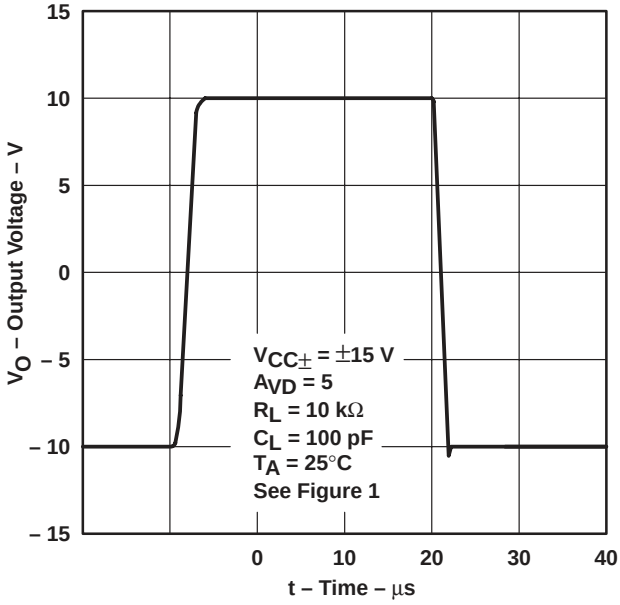

Figure 27

TYPICAL CHARACTERISTICS

NOISE VOLTAGE (REFERRED TO INPUT) OVER A 10-SECOND INTERVAL

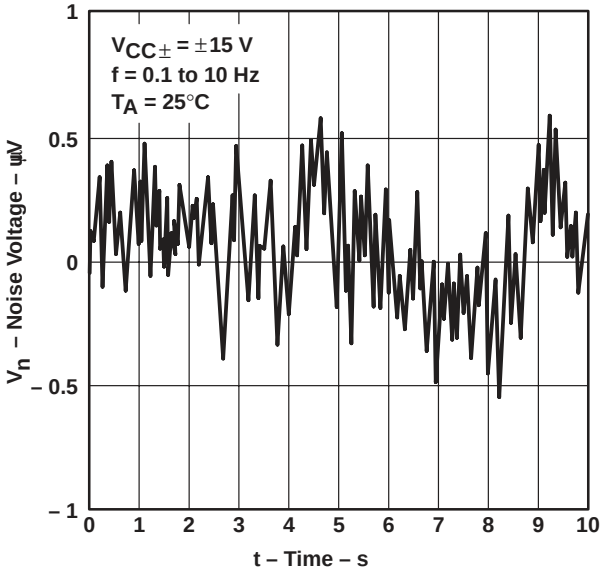

Figure 28

EQUIVALENT INPUT NOISE VOLTAGE vs FREQUENCY

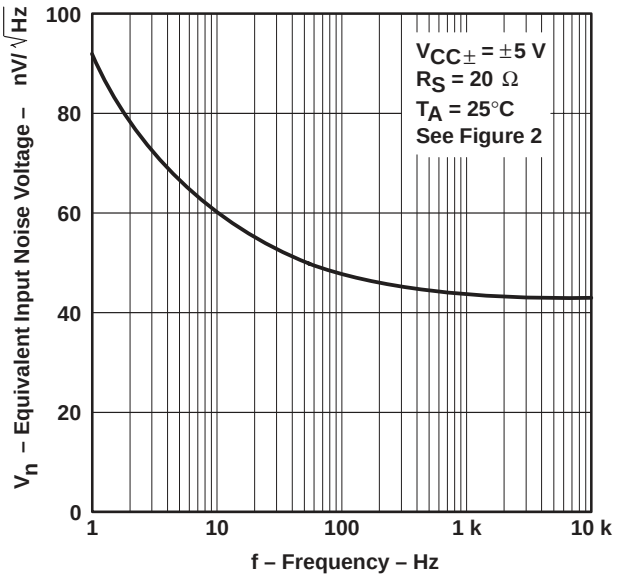

Figure 29

TOTAL HARMONIC DISTORTION vs FREQUENCY

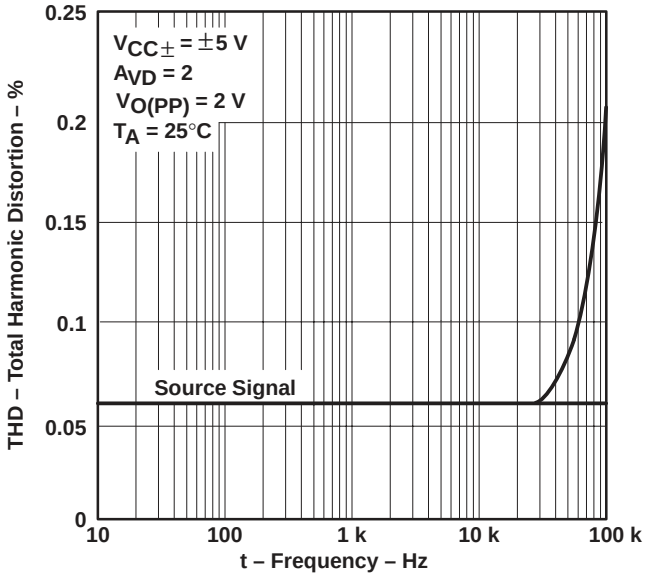

Figure 30

TOTAL HARMONIC DISTORTION vs FREQUENCY

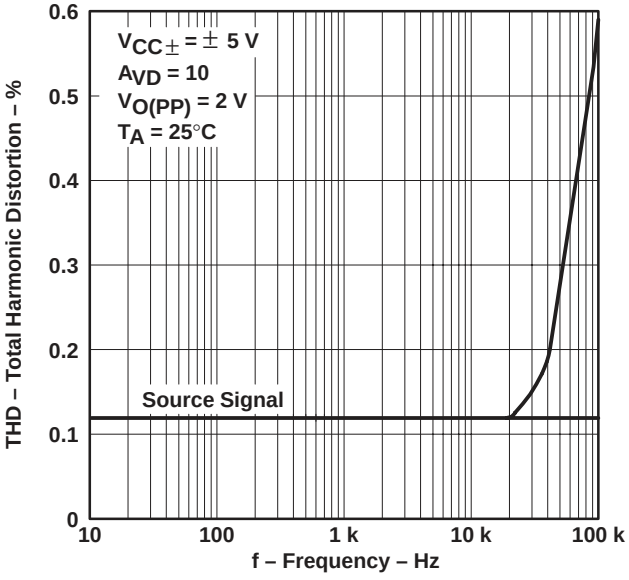

Figure 31

TYPICAL CHARACTERISTICS

GAIN-BANDWIDTH PRODUCT vs SUPPLY VOLTAGE

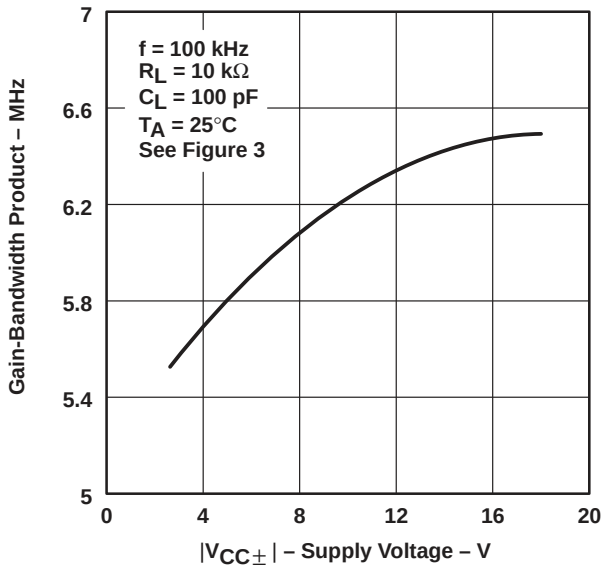

Figure 32

GAIN-BANDWIDTH PRODUCT vs FREE-AIR TEMPERATURE

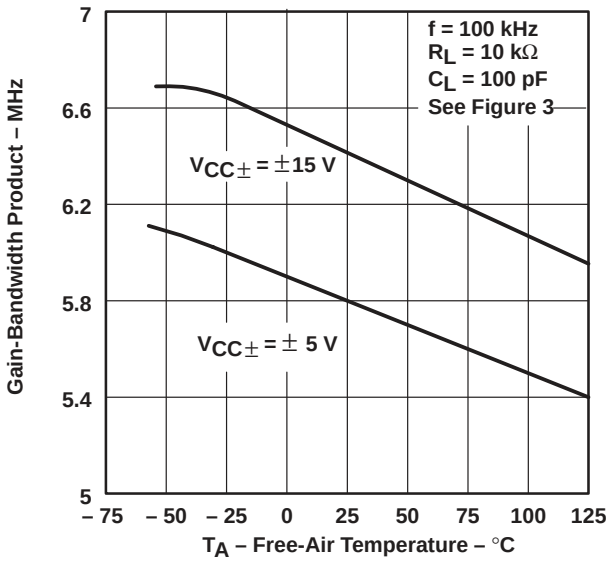

Figure 33

PHASE MARGIN vs SUPPLY VOLTAGE

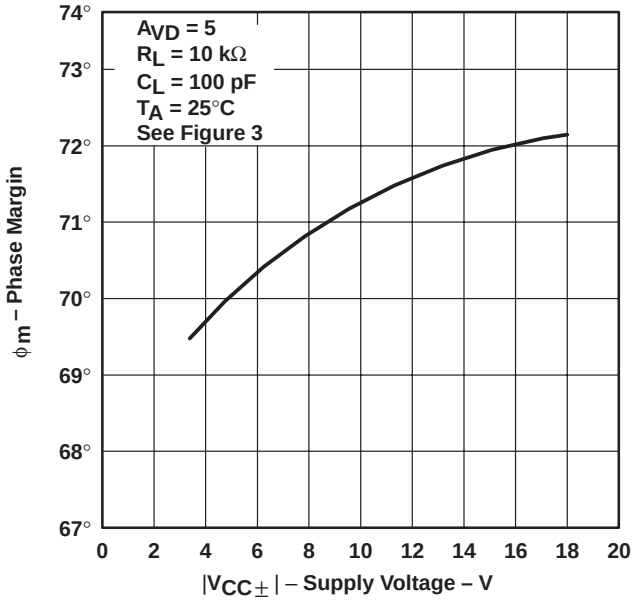

Figure 34

PHASE MARGIN vs FREE-AIR TEMPERATURE

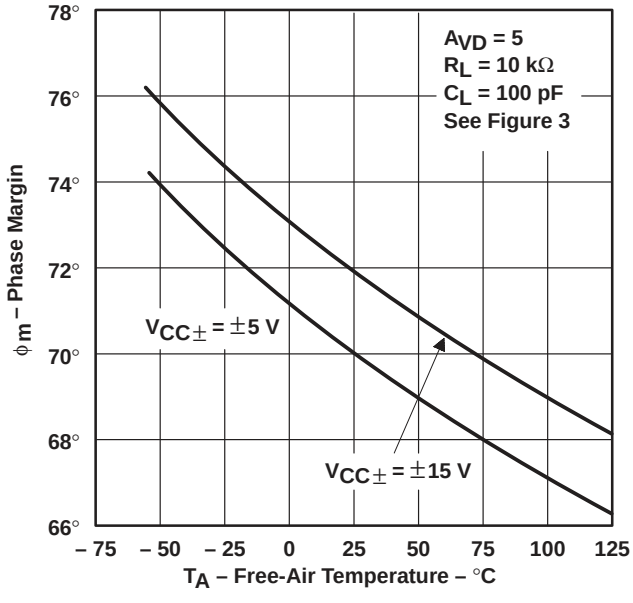

Figure 35

APPLICATION INFORMATION

macromodel information

Macromodel information provided was derived using Microsim *Parts*™, the model generation software used with Microsim *PSpice*™. The Boyle macromodel (see Note 5) and subcircuit in Figure 36 and Figure 37 were generated using the TLE2161 typical electrical and operating characteristics at 25°C. Using this information, output simulations of the following key parameters can be generated to a tolerance of 20% (in most cases):

- Maximum positive output voltage swing
- Maximum negative output voltage swing
- Slew rate
- Quiescent power dissipation
- Input bias current
- Open-loop voltage amplification
- Gain-bandwidth product
- Common-mode rejection ratio
- Phase margin
- DC output resistance
- AC output resistance
- Short-circuit output current limit

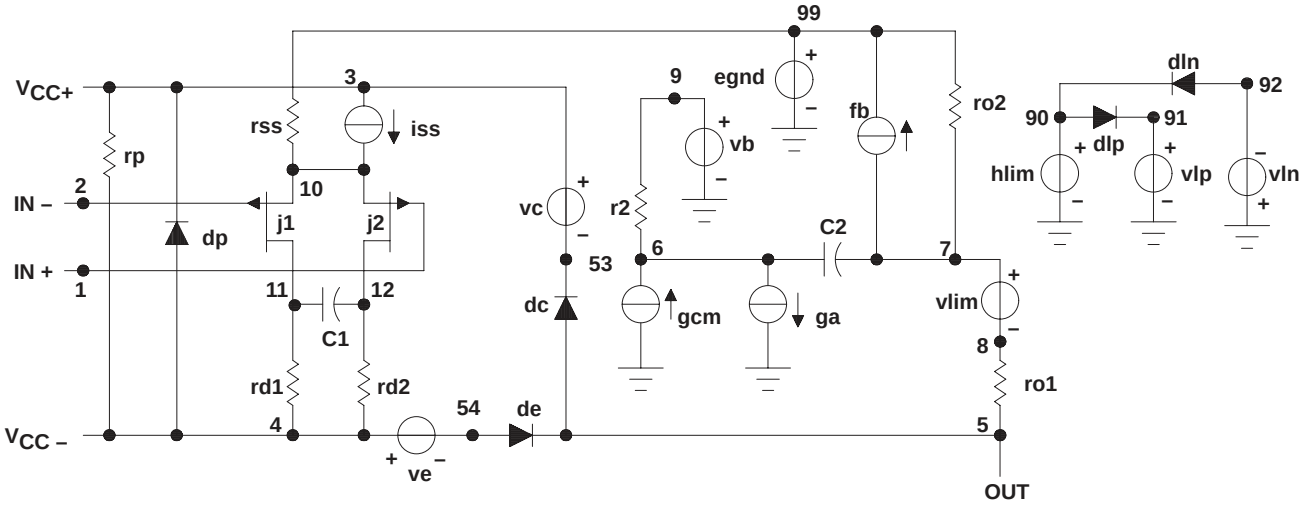

Figure 36. Boyle Macromodel

NOTE 5: G. R. Boyle, B. M. Cohn, D. O. Pederson, and J. E. Solomon, "Macromodeling of Integrated Circuit Operational Amplifiers", *IEEE Journal of Solid-State Circuits*, SC-9, 353 (1974).

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APPLICATION INFORMATION

macromodel information (continued)

```
.subckt TLE2161 1 2 3 4 5
 c1    11  12  125.4E–14
 c2     6   7  5.000E–12
 dc     5  53  dx
 de    54  5d  x
 dlp   90  91  dx
 dln   92  90  dx
 dp     4   3  dx
 egnd  99   0  poly(2) (3,0) (4,0) 0 .5 .5
 fb     7  99  poly(5) vb vc ve vlp vln 0 4.085E6 –4E6 4E6 4E6 –4E6
 ga     6   0  11 12 201.1E–6
 gcm    0   6  10 99 3.576E–9
 iss    3  10  dc 45.00E–6
 hlim  90   0  vlim 1K
 j1    11   2  10 jx
 j2    12   1  10 jx
 r2     6   9  100.0E3
 rd1    4  11  4.973E3
 rd2    4  12  4.973E3
 ro1    8   5  280
 ro2    7  99  280
 rp     3   4  113.2E3
 rss   10  99  4.444E6
 vb     9   0  dc 0
 vc     3  53  dc 2
 ve    54   4  dc 2
 vlim   7   8  dc 0
 vlp   91   0  dc 50
 vln    0  92  dc 50
.model dx   D  (Is=800.0E–18)
.model jx PJF  (Is=1.000E–12 Beta=480E–6 Vto=–1)
.ends
```

Figure 37. Macromodel Subcircuit

APPLICATION INFORMATION

input characteristics

The TLE2161, TLE2161A and TLE2161B are specified with a minimum and a maximum input voltage that if exceeded at either input could cause the device to malfunction.

Because of the extremely high input impedance and resulting low bias-current requirements, the TLE2161, TLE2161A, and TLE2161B are well suited for low-level signal processing; however, leakage currents on printed circuit boards and sockets can easily exceed bias-current requirements and cause degradation in system performance. It is a good practice to include guard rings around inputs (see Figure 38). These guards should be driven from a low-impedance source at the same voltage level as the common-mode input.

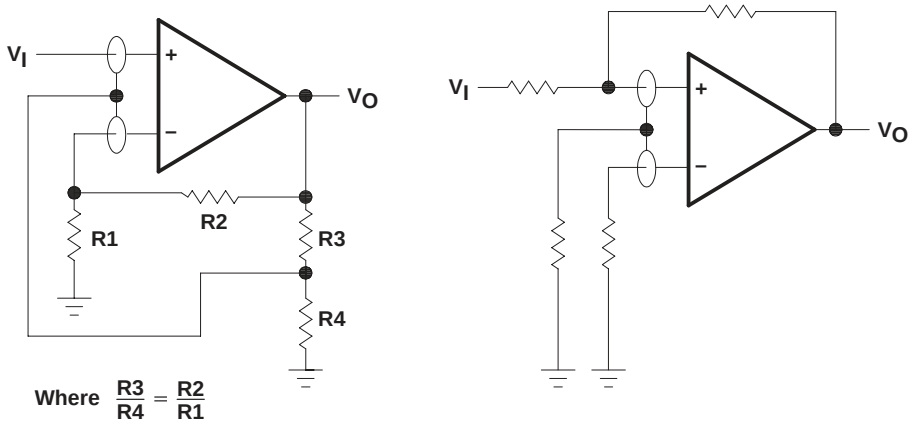

Figure 38. Use of Guard Rings

input offset voltage nulling

The TLE2161 series offers external null pins that can further reduce the input offset voltage. The circuit in Figure 39 can be connected as shown if the feature is desired. When external nulling is not needed, the null pins may be left disconnected.

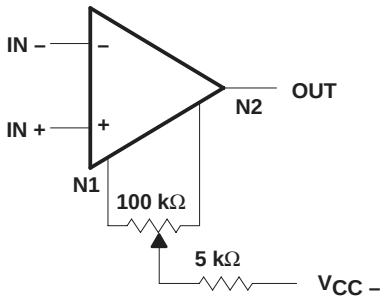

Figure 39. Input Offset Voltage Nulling

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
5962-9095801QPA	ACTIVE	CDIP	JG	8	1	TBD	A42	N / A for Pkg Type	-55 to 125	9095801QPA TLE2161M	Samples
5962-9095802QPA	ACTIVE	CDIP	JG	8	1	TBD	A42	N / A for Pkg Type	-55 to 125	9095802QPA TLE2161AM	Samples
5962-9095803QPA	ACTIVE	CDIP	JG	8	1	TBD	A42	N / A for Pkg Type	-55 to 125	9095803QPA TLE2161BM	Samples
TLE2161ACD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	2161AC	Samples
TLE2161ACP	OBSOLETE	PDIP	P	8		TBD	Call TI	Call TI	0 to 70		
TLE2161AID	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		2161AI	Samples
TLE2161AIDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		2161AI	Samples
TLE2161AIDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		2161AI	Samples
TLE2161AIP	OBSOLETE	PDIP	P	8		TBD	Call TI	Call TI			
TLE2161AMJGB	ACTIVE	CDIP	JG	8	1	TBD	A42	N / A for Pkg Type	-55 to 125	9095802QPA TLE2161AM	Samples
TLE2161BCP	OBSOLETE	PDIP	P	8		TBD	Call TI	Call TI	0 to 70		
TLE2161BIP	OBSOLETE	PDIP	P	8		TBD	Call TI	Call TI			
TLE2161BMJGB	ACTIVE	CDIP	JG	8	1	TBD	A42	N / A for Pkg Type	-55 to 125	9095803QPA TLE2161BM	Samples
TLE2161BMP	OBSOLETE	PDIP	P	8		TBD	Call TI	Call TI	-55 to 125		
TLE2161CD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	2161C	Samples
TLE2161CDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	2161C	Samples
TLE2161CP	OBSOLETE	PDIP	P	8		TBD	Call TI	Call TI	0 to 70		
TLE2161ID	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		2161I	Samples
TLE2161IDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		2161I	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
TLE2161IDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		2161I	Samples
TLE2161IDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		2161I	Samples
TLE2161IP	OBSOLETE	PDIP	P	8		TBD	Call TI	Call TI			
TLE2161MJGB	ACTIVE	CDIP	JG	8	1	TBD	A42	N / A for Pkg Type	-55 to 125	9095801QPA TLE2161M	Samples
TLE2161MP	OBSOLETE	PDIP	P	8		TBD	Call TI	Call TI	-55 to 125		

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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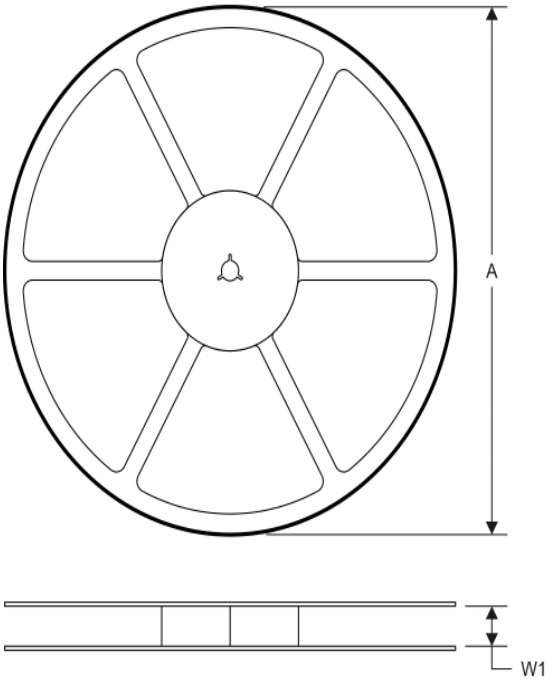
- Catalog: TLE2161A, TLE2161B, TLE2161
- Military: TLE2161M, TLE2161AM, TLE2161BM

NOTE: Qualified Version Definitions:

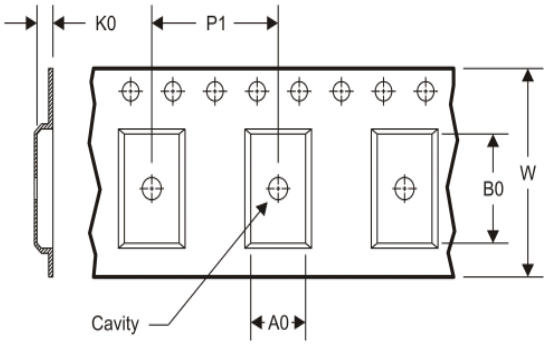
- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS



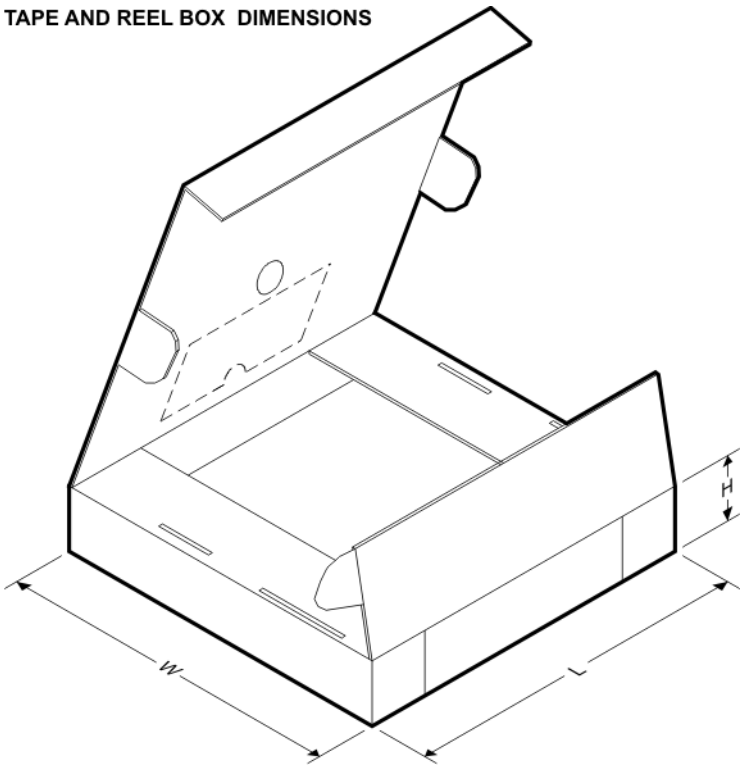
A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

TAPE AND REEL INFORMATION

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TLE2161AIDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLE2161IDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLE2161IDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TLE2161AIDR	SOIC	D	8	2500	340.5	338.1	20.6
TLE2161IDR	SOIC	D	8	2500	367.0	367.0	35.0
TLE2161IDR	SOIC	D	8	2500	340.5	338.1	20.6

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